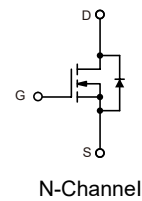
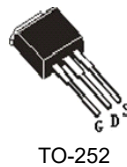
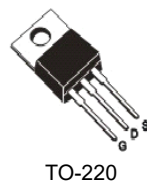


1.Features

- $V_{DS(V)}=650V$
- $I_D=5A$
- $R_{DS(ON)}=2\Omega$

2.Pinning information

Pin	Symbol	Description
1	G	GATE
2	D	DRAIN
3	S	SOURCE



3.Absolute Maximum Ratings $T_c=25^{\circ}C$

Parameter		Symbol	Rating	Units
Drain-source Voltage		V_{DS}	650	V
gate-source Voltage		V_{GS}	± 30	V
Continuous Drain Current	$T_c=25^{\circ}C$	I_D	5	A
Continuous Drain Current	$T_c=100^{\circ}C$	I_D	3.15	A
Drain Current – Pulsed ①		I_{DM}	20	A
Power Dissipation		P_{tot}	TO-220:120,TO-220FP:50	W
			TO-262/263:120	W
Junction Temperature		T_J	150	$^{\circ}C$
Storage Temperature		T_{STG}	-55 to 150	$^{\circ}C$
Single Pulse Avalanche Energy ②		E_{AS}	210	mJ



4.Thermal resistance rating

Parameter	Symbol	MAX			Units
		TO-220	TO-220FP	TO-262/263	
Thermal Resistance Junction-case	R _{thJC}	1.04	2.50	1.04	°C/W
Thermal Resistance Junction-ambient	R _{thJA}	62.5	62.5	62.5	°C/W



5. Electrical Characteristic ($T_c=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Drain-source Breakdown Voltage	BV_{DSS}	$V_{GS}=0V, I_D=250\mu A$		650		V
Breakdown Voltage Temperature Coefficient	$\frac{\Delta BV_{DSS}}{\Delta T_J}$	$I_D=250\mu A$ Referenced to 25°C		0.6		$V/^\circ\text{C}$
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	2		4	V
Drain-source Leakage Current	I_{DSS}	$V_{DS}=650V, V_{GS}=0V, T_J=25^\circ\text{C}$			10	μA
		$V_{DS}=480V, V_{GS}=0V, T_J=125^\circ\text{C}$			100	μA
Forward Transconductance	g_{fs}	$V_{GS}=40V, I_D=2.5A$ ③		4		S
Gate-body Leakage Current ($V_{DS}=0$)	I_{GSS}	$V_{GS}=\pm 30V$			± 100	nA
Static Drain-source On Resistance	$R_{DS(on)}$	$V_{GS}=10V, I_D=2.5A$ ③		1.5	2	Ω
Input capacitance	C_{iss}	$V_{GS}=0V, V_{DS}=25V, f=1\text{MHz}$		730		pF
Output capacitance	C_{oss}			25		pF
Reverse transfer capacitance	C_{rss}			16		pF
Turn -Off Delay Time	$t_{D(off)}$	$V_{DD}=300V, I_D=5A, R_G=25\Omega$ ③		38		ns
Total Gate Charge	Q_g	$I_D=5A, V_{DS}=480V, V_{GS}=10V$ ③		15		nC
Gate-to-Source Charge	Q_{gs}			3.7		nC
Gate-to-Drain Charge	Q_{gd}			4.8		nC
Continuous Diode Forward Current	I_S				5	A
Diode Forward Voltage	V_{SD}	$T_J=25^\circ\text{C}, I_S=5A, V_{GS}=0V$ ③			1.4	V
Reverse Recovery Time	t_{rr}	$T_J=25^\circ\text{C}, I_F=5A$		270		ns
Reverse Recovery Charge	Q_{rr}	$di/dt=100A/\mu s$ ③		1.9		μC

Notes:

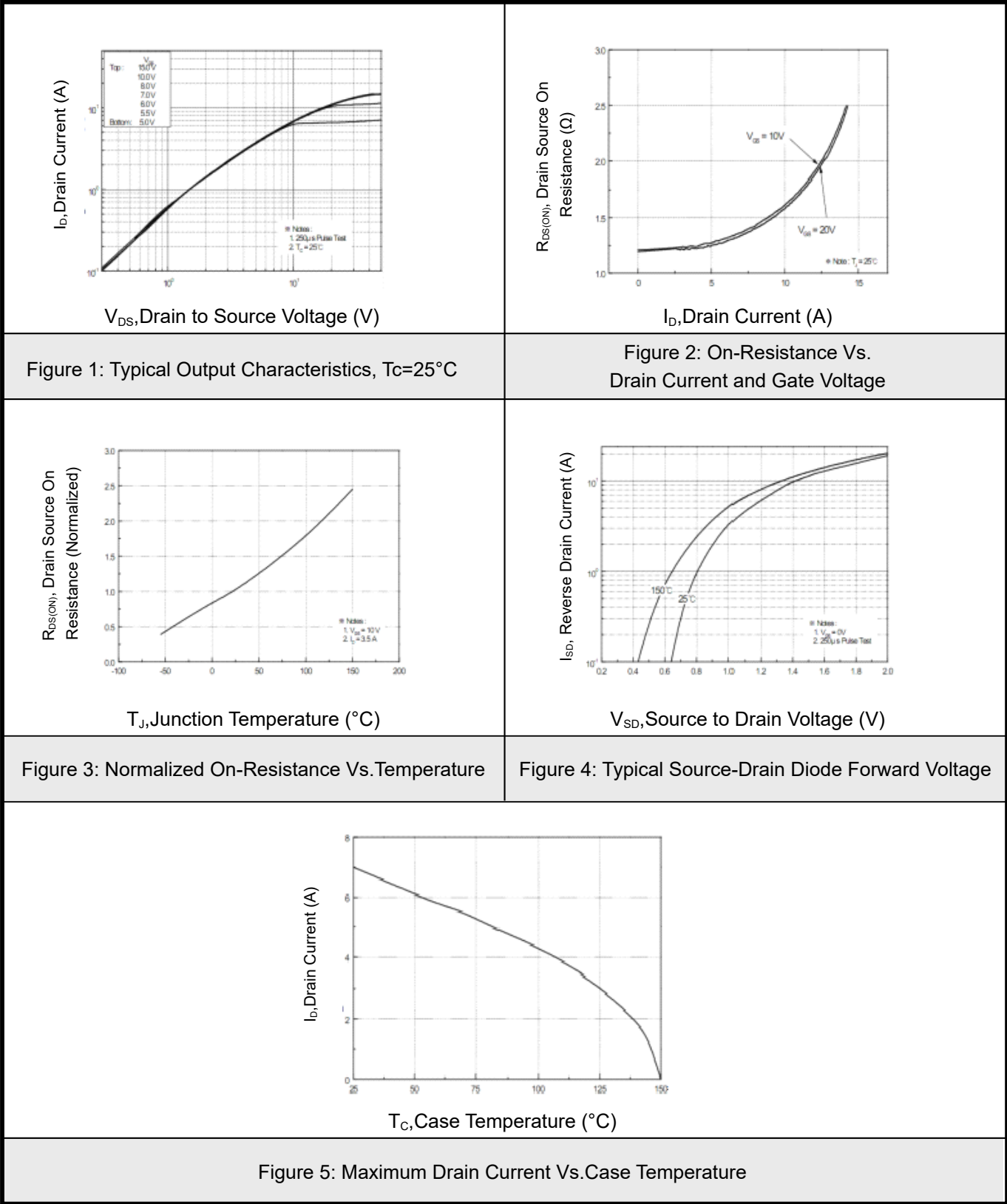
① Repetitive rating: Pulse width limited by maximum junction temperature.

② Starting $T_J=25^\circ\text{C}$, $V_{DD}=50V$, $L=18.9\text{mH}$, $R_G=25\Omega$, $I_{AS}=5A$.

③ Pulse Test : Pulse width $\leq 300\mu s$, Duty cycle $\leq 2\%$.

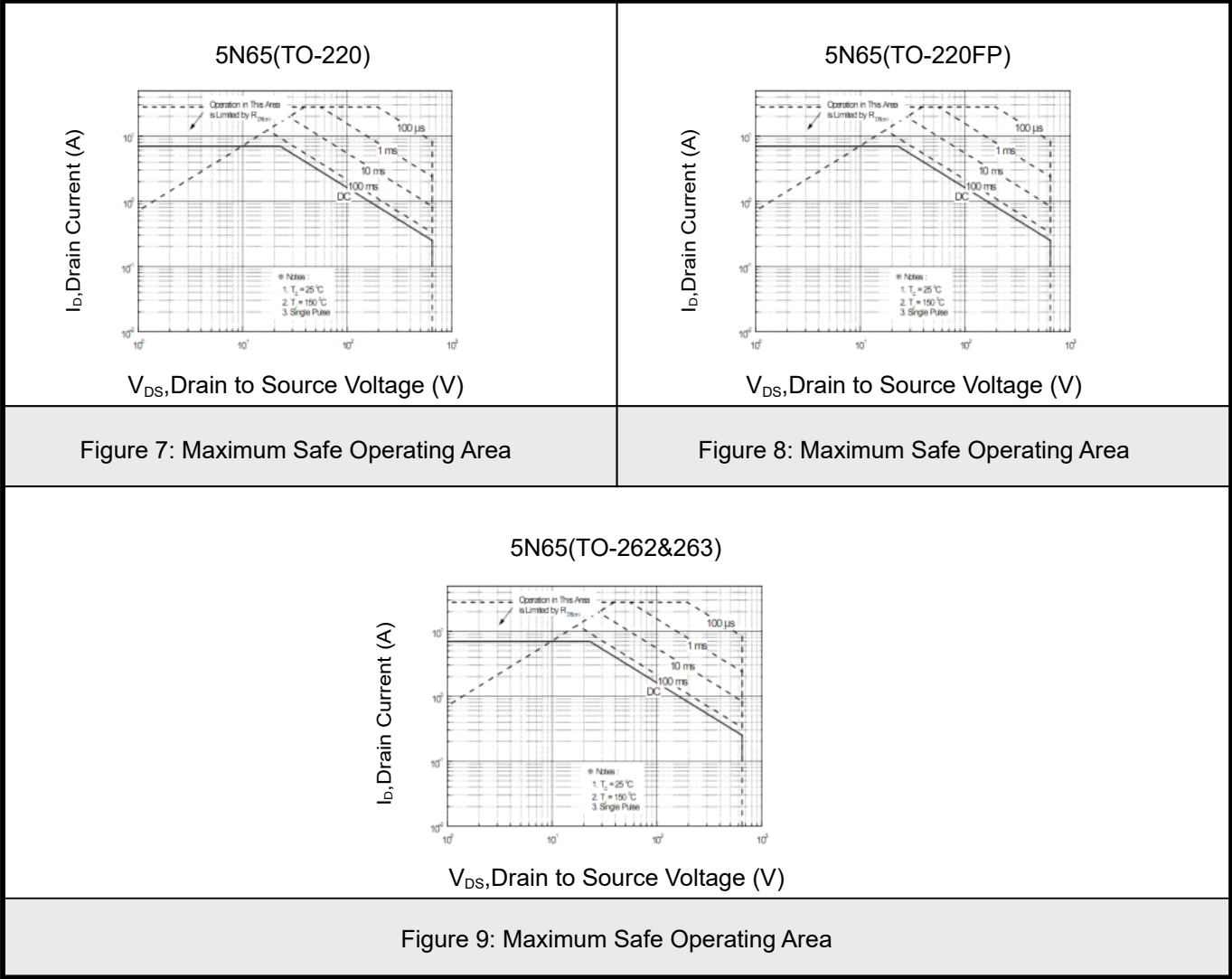


6.1Typical characteristic



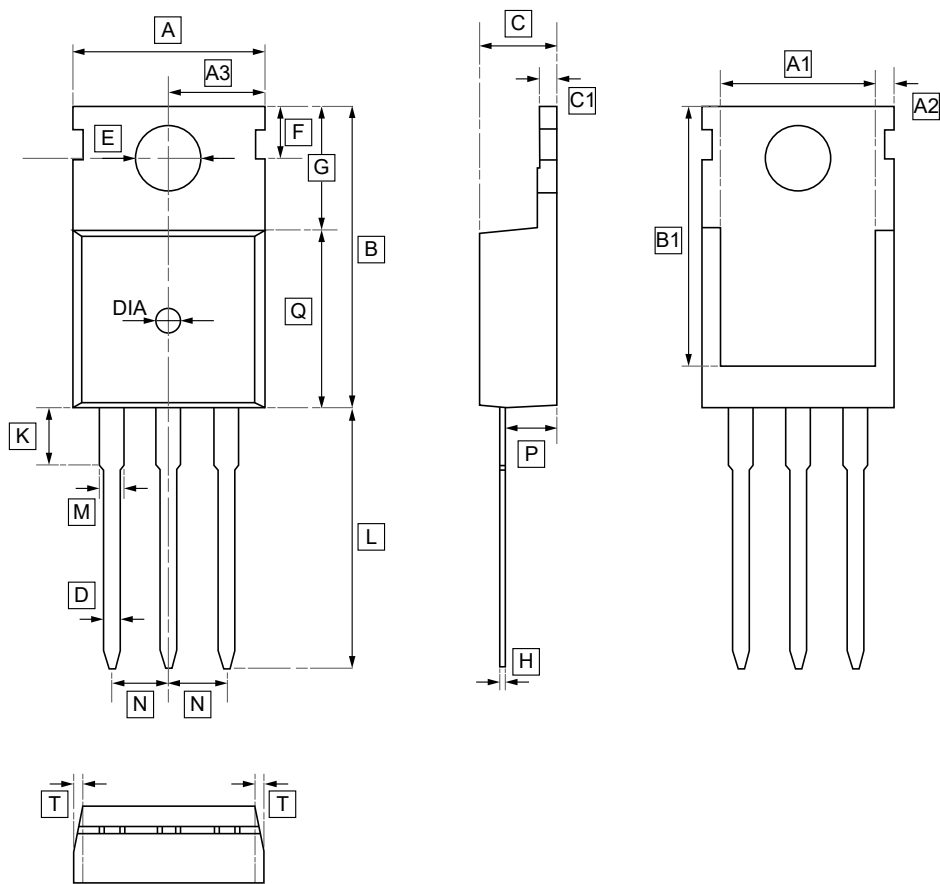


6.2Typical characteristic





7.1TO-220 Package Outline Dimensions



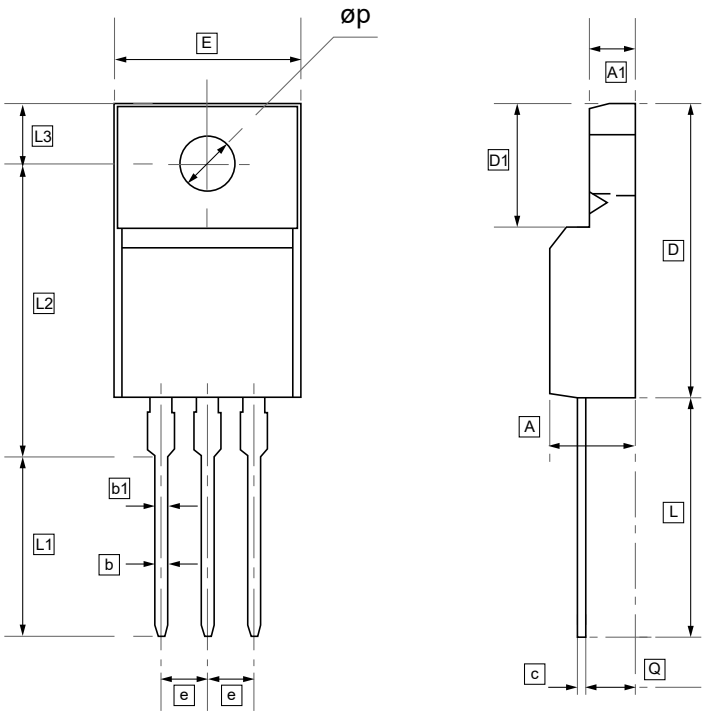
DIMENSIONS (mm are the original dimensions)

Symbol	A	A1	A2	A3	B	B1	C	C1	D	E	F	G
Min	9.7	8.44	1.05	4.8	15.4	12.9	4.28	1.1	0.6	3.4	2.65	5.2
Max	10.3	8.84	1.25	5.2	16.2	13.5	4.68	1.5	1.0	3.8	3.25	5.8

Symbol	H	K	L	L1	M	N	P	Q	T	DIA
Min	0.4	2.9	12.8	2.7	1.15	2.49	2.1	8.7	W:0.35	⌀1.5
Max	0.6	3.3	13.6	3.3	1.35	2.59	2.7	9.3		(deep 0.2)



7.2TO-220FP Package Outline Dimensions

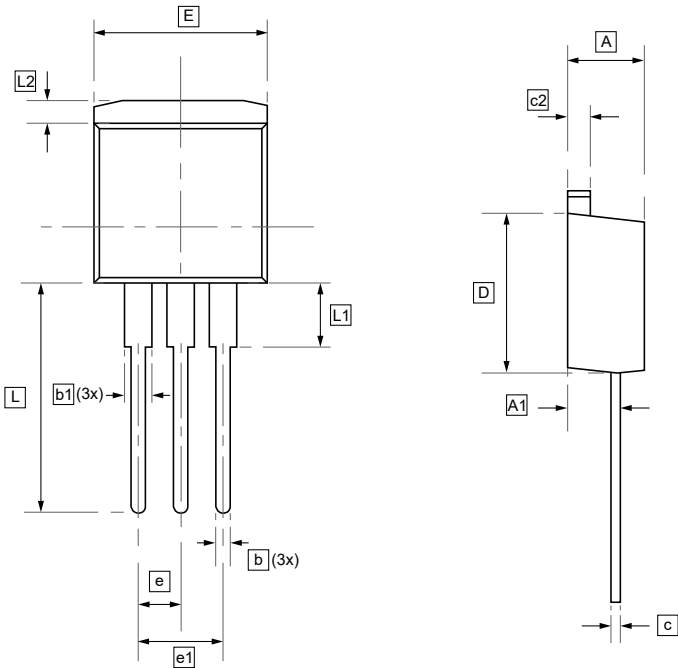


DIMENSIONS (mm are the original dimensions)

Symbol	A	A1	b	b1	c	D	D1	E	e	L	L1	L2	L3	ϕp	Q
Min	4.40	2.30	0.45	1.10	0.35	14.50	6.10	9.60	-	12.50	9.10	15.00	3.00	3.00	2.30
Max	4.95	2.90	0.90	1.70	0.90	17.00	9.00	10.30	-	14.30	10.05	16.00	4.00	3.50	2.80



7.3TO-262 Package Outline Dimensions

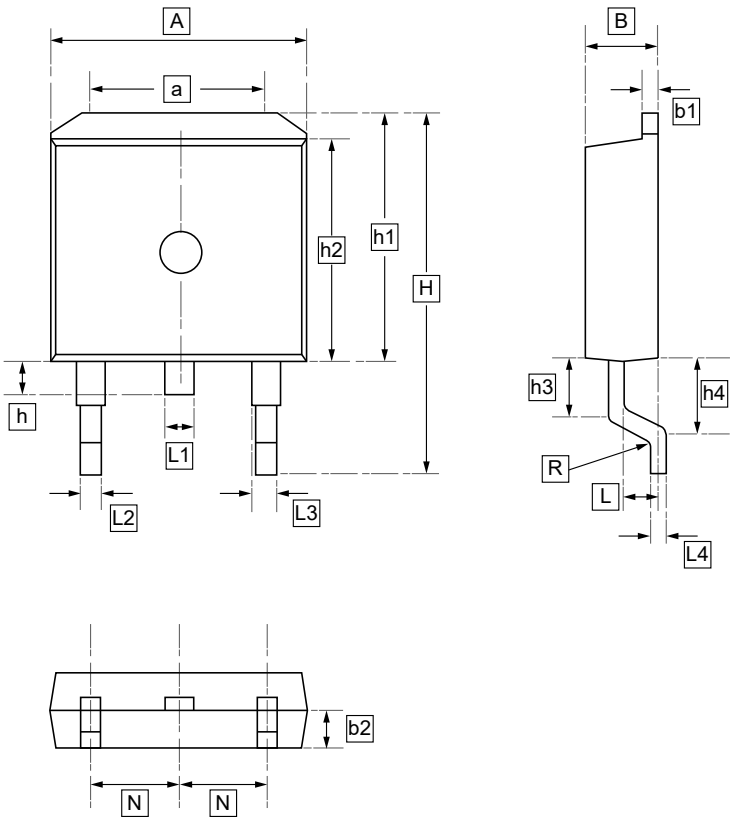


DIMENSIONS (mm are the original dimensions)

Symbol	A	A1	b	b1	c	c2	D	e	e1	E	L	L1	L2
Min	3.80	2.00	0.60	1.20	0.40	1.10	-	-	-	9.90	12.50	0.80	-
Max	4.80	2.80	1.00	1.40	0.70	1.40	9.60	-	5.30	10.70	14.50	1.20	1.50



7.4TO-263 Package Outline Dimensions



DIMENSIONS (mm are the original dimensions)

Symbol	A	a	B	b1	b2	H	h	h1	h2	h3	h4	L	L1	L2	L3
Min	9.6	7.2	4.3	1.25	2.2	15.2	1.34	10.3	9.1	1.34	2.5	2.2	1.2	0.7	1.2
Max	10.0	7.6	4.7	1.35	2.6	15.8	1.74	10.7	9.3	1.74	2.9	2.6	1.4	0.9	1.4

Symbol	L4	N	R
Min	0.4	2.4	0.45
Max	0.6	2.5	0.55



8.Ordering information



yy: Year Code
ww: Week Code

Order Code	Package	Base QTY	Delivery Mode
UMW 5N65F	TO-220F	1000	Tape and box



9.Disclaimer

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